<table>
<thead>
<tr>
<th>Item No.</th>
<th>Designator</th>
<th>Quantity</th>
<th>Value</th>
<th>Part Number</th>
<th>Manufacturer</th>
<th>Description</th>
<th>Packaging</th>
<th>Typical Dimension mm(inches)</th>
</tr>
</thead>
<tbody>
<tr>
<td>1</td>
<td>C1,C2</td>
<td>2</td>
<td>1μF</td>
<td></td>
<td></td>
<td>Ceramic, 50V, ±10%</td>
<td>-</td>
<td>3.2 x 1.6 (1206)</td>
</tr>
<tr>
<td>2</td>
<td>Q1,Q2</td>
<td>2</td>
<td></td>
<td>SSM6K513NU</td>
<td>TOSHIBA</td>
<td></td>
<td>UDFN6B</td>
<td>2.0 x 2.0</td>
</tr>
<tr>
<td>3</td>
<td>IC1</td>
<td>1</td>
<td></td>
<td>TCK401G</td>
<td>TOSHIBA</td>
<td></td>
<td>WCSP6E</td>
<td>0.8 x 1.2</td>
</tr>
</tbody>
</table>
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